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**HEARING AID**

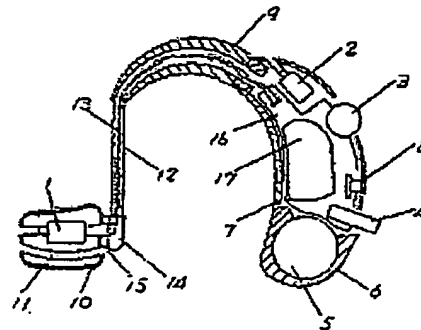
**Patent number:** JP62151100  
**Publication date:** 1987-07-06  
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**Classification:**  
 - international: H04R25/02; H04R25/02; (IPC1-7): H04R25/02  
 - european:  
**Application number:** JP19850295251 19851225  
**Priority number(s):** JP19850295251 19851225

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**Abstract of JP62151100**

**PURPOSE:** To obtain a flat frequency characteristic compared with the frequency characteristic of a conventional ear hooking type hearing aid by assembling an inner packaging earphone in an ear mold shell formed fitting the ear type of a user.

**CONSTITUTION:** An inner packaging earphone 1 is assembled in an ear mold 10 formed from the ear type of the user. Also, in the ear mold 10, a vent 11 for ventilation is formed. At the ear mold 10 on which the inner packaging earphone 1 is mounted, a connector 15 facing with a connector 14 at a main body side is provided, and receives an electrical signal from the main body side, and connects it to the inner packaging earphone 1. By placing the earphone within an external auditory meatus, the frequency characteristic can be made flat.



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